

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT6555945

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	JOE W. MCPHERSON	02/17/2021
RECEIVING PARTY DATA		
Name:	LOU HUTTER CONSULTING LLC	
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City:	DALLAS	
State/Country:	TEXAS	
Postal Code:	75219	
PROPERTY NUMBERS Total: 1		
	Property Type	Number
	Application Number:	17177641
CORRESPONDENCE DATA		
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
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ATTORNEY DOCKET NUMBER:	1194-485	
NAME OF SUBMITTER:	FRAN LAFRANKIE	
SIGNATURE:	/FRAN LAFRANKIE/	
DATE SIGNED:	02/17/2021	
Total Attachments: 3		
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ASSIGNMENT

This Assignment made by **Joe W. McPherson**, being a citizen of the United States and having a correspondence address of 2805 Shelton Way, Plano, Texas 75093;

WITNESSETH: That,

WHEREAS, I believe I am the original inventor or an original joint inventor of certain new and useful improvements in U.S. Patent Application titled "Power Semiconductor Die with Reduced Strain", attorney docket number(s) 1194-485 and/or P3125US, with inventors Daniel Jenner Lichtenwalner, Edward Robert Van Brunt, Thomas E. Harrington, III, Shadi Sabri, Brett Hull, Brice McPherson, and Joe W. McPherson to be filed on behalf of Cree, Inc. (herein referred to as the Application); and

WHEREAS, **Lou Hutter Consulting LLC**, a limited liability company duly organized and existing under the laws of the State of Texas and having a principal place of business at 2323 North Houston Street, #602, Dallas, Texas 75219, hereinafter referred to as Assignee, is desirous of acquiring the entire right, title and interest in and to said invention as described in the Application, and any and all Letters Patent which shall be granted therefor;

NOW, THEREFORE, To All Whom It May Concern, be it known that for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I hereby sell, assign, transfer and set over unto the Assignee, its successors and assigns, the entire right, title and interest in and to the invention and the Application and in and to any and all foreign patent applications filed on the invention based on and claiming priority to the Application, and in and to any and all Letters Patent of the United States and foreign countries which may hereafter be granted therefor, and in any and to any and all continuations, continuations-in-part, substitutions, divisions or reissues of said Letters Patent, the same to be held and enjoyed by the Assignee, for its interest,

and for its own use and behalf, and the use and behalf of its successors and assigns, to the full end of the term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me had this assignment and sale not been made, and I hereby authorize and empower the Assignee, its successors, assigns or nominees to file applications for any Letters Patent or other form of protection on said invention in its own name or in the name of its successor, assignee, or nominee, in any and all countries where it may desire to file such applications and where said applications may be filed by another than the inventor;

And for the consideration aforesaid, I further covenant and agree that, at the time of the execution and delivery of these presents, I have the unencumbered right and authority to make this assignment, and I have not executed any prior assignment(s) or created any encumbrances relating to the Application mentioned above to any person or entity other than the Assignee identified herein;

And for the consideration aforesaid, I hereby covenant and agree to and with the Assignee, its successors and assigns, that I will, whenever its counsel or the counsel of its successors and assigns, learned in the law, shall advise that an amendment, division, continuation, continuation-in-part, or substitution of, or any other proceeding in connection with said application, including interference proceedings, is lawful and desirable, sign all papers and drawings, take all rightful oaths, and do all acts necessary or required to be done for the procurement of valid Letters Patent for said invention, or for the reissue of the same without charge to the Assignee, its successors or assigns, but at its or their expense, and I hereby covenant and agree to sign all papers and drawings, take all rightful oaths, and do all acts necessary or required to be done for procurement of Letters Patent, or other form of protection, for said invention or inventions in countries foreign to the United States, and for further investing or confirming the right and title therein to the Assignee, its

successors, assignee, or nominee, without charge to the Assignee, its successor, assignee or nominee, but at its or their own expense;

I hereby request the Commissioner for Patents and other applicable patent authorities to issue the Letters Patent in accordance with this instrument;

IN WITNESS WHEREOF, I have hereunto set my hand and seal.



2/17/21
Date

Joe W. McPherson